

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	V
RMS Reverse Voltage	$V_{R(RMS)}$	141	V
Average Rectified Output Current	I_O	4	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-wave Superimposed on Rated Load	I_{FSM}	100	A
Electrostatic Discharge	HBM	4	kV
Electrostatic Discharge	CDM	1	kV

Thermal Characteristics (Note 5)

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{\theta JS}$	—	3.0	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{\theta JA}$	80	—	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient Air (Note 7)	$R_{\theta JA}$	65	—	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient Air (Note 8)	$R_{\theta JA}$	45	—	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +175		$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 9)	$V_{(BR)R}$	200	—	—	V	$I_R = 5\mu\text{A}$
Forward Voltage	V_F	—	0.76	0.82	V	$I_F = 3\text{A}, T_S = +25^\circ\text{C}$
		—	—	0.59		$I_F = 3\text{A}, T_S = +150^\circ\text{C}$
		—	0.785	0.84		$I_F = 4\text{A}, T_S = +25^\circ\text{C}$
		—	0.61	0.64		$I_F = 4\text{A}, T_S = +150^\circ\text{C}$
		—	0.84	0.89		$I_F = 8\text{A}, T_S = +25^\circ\text{C}$
		—	0.68	0.75		$I_F = 8\text{A}, T_S = +150^\circ\text{C}$
Reverse Leakage Current (Note 9)	I_R	—	0.2	1	μA	$T_S = +25^\circ\text{C}, V_R = 200\text{V}$
		—	0.8	4	mA	$T_S = +150^\circ\text{C}, V_R = 200\text{V}$
Reverse Recovery Time	t_{RR}	—	13	25	ns	$I_F = 0.5\text{A}, I_R = 1.0\text{A}$ $I_{RR} = 0.25\text{A}$ (See Figure 9)

- Notes:
- The heat generated must be less than thermal conductivity from junction-to-ambient: $dPD/DT_J < 1/R_{\theta JA}$
 - FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
 - Polymide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
 - Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
 - Short duration test pulse used to minimize self-heating effect.

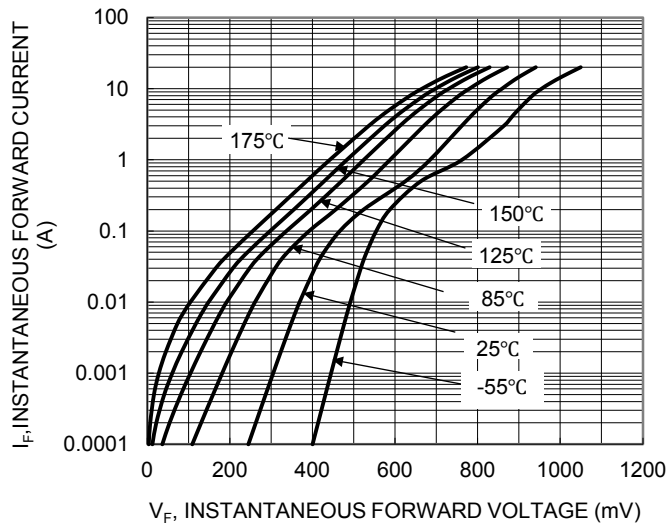


Figure 1. Typical Forward Characteristics

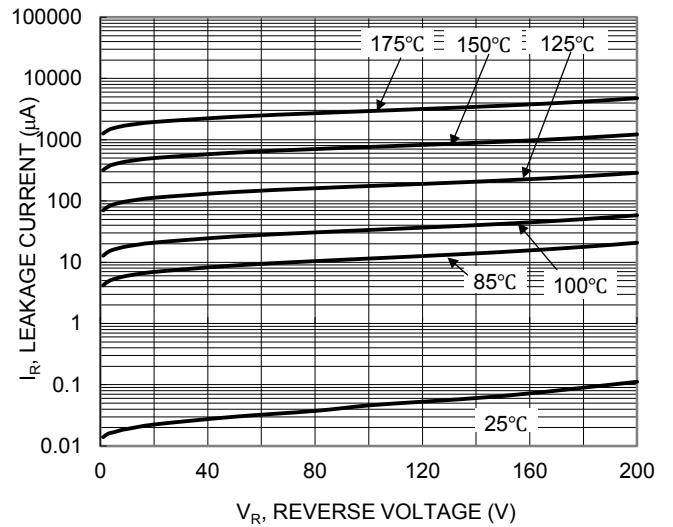


Figure 2. Typical Reverse Characteristics

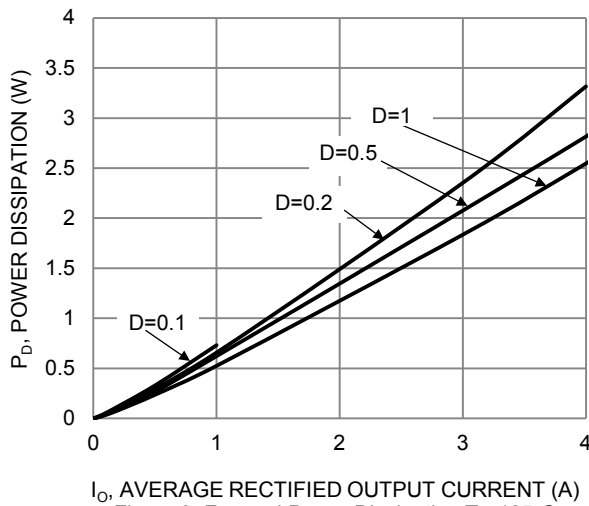


Figure 3. Forward Power Dissipation $T_J=125^\circ\text{C}$

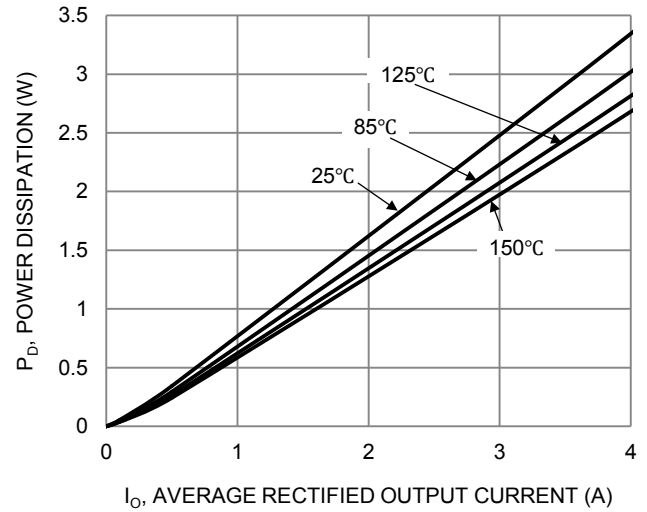


Figure 4. Forward Power Dissipation $D=0.5$

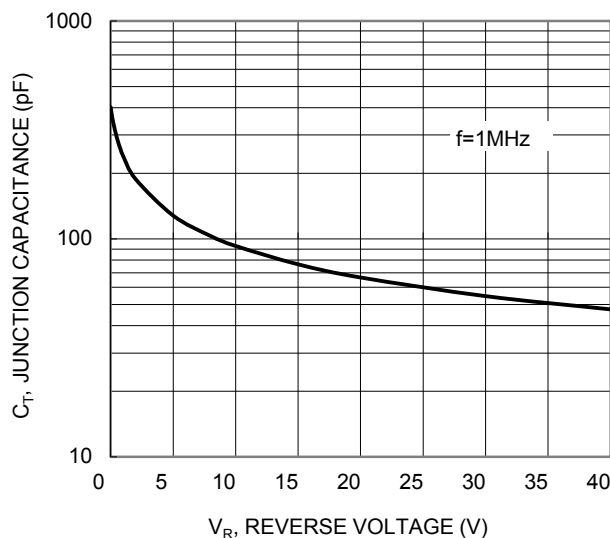


Figure 5. Typical Junction Capacitance

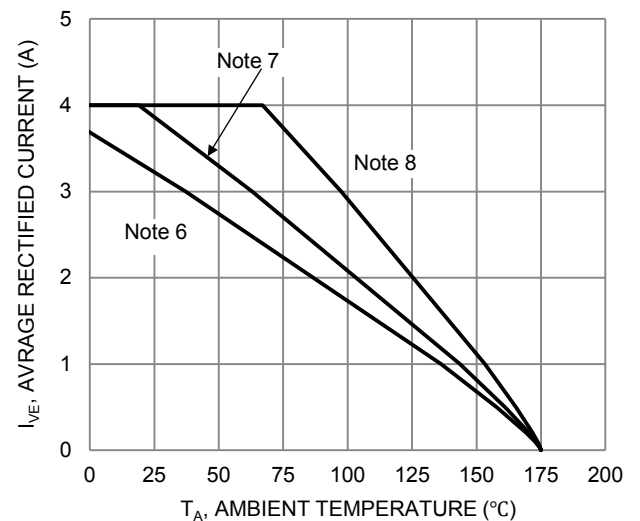


Figure 6. DC Forward Current Derating

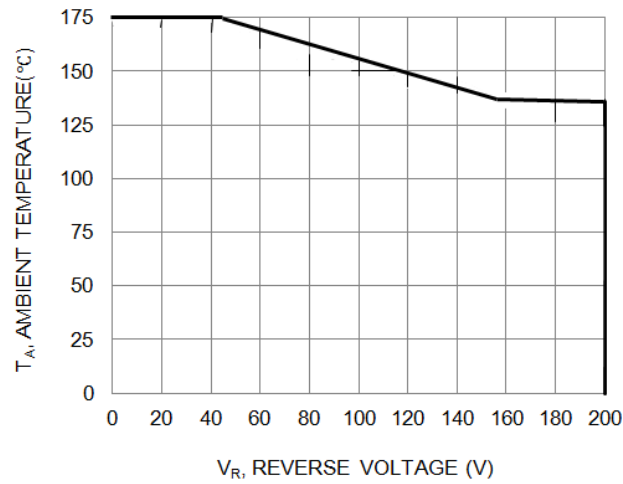


Figure 7. Operating Temperature Derating

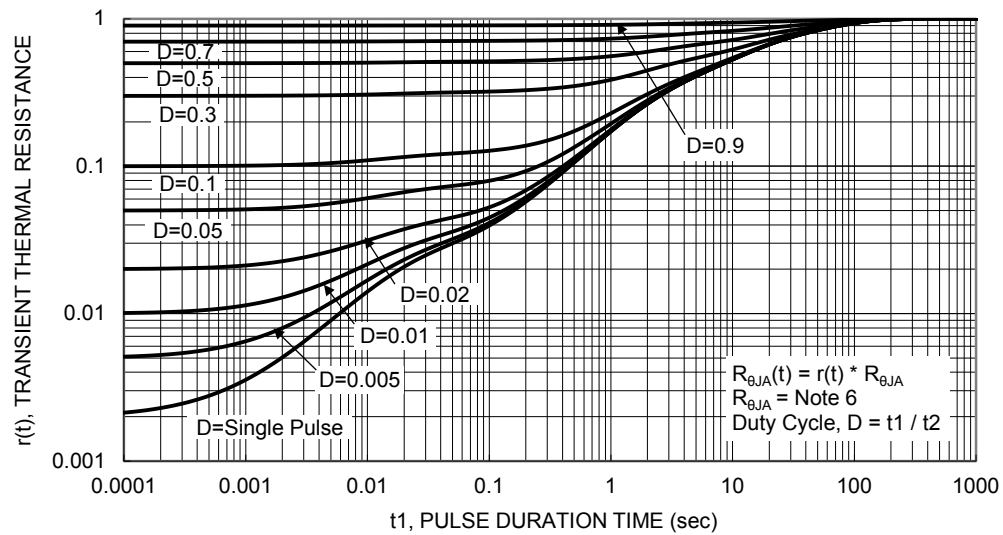


Figure 8. Transient Thermal Resistance

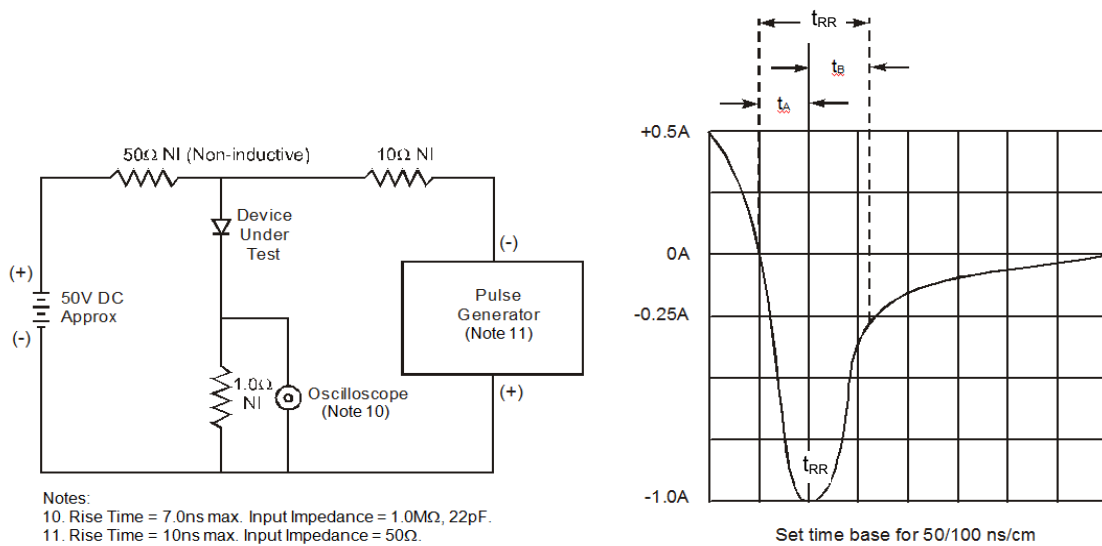
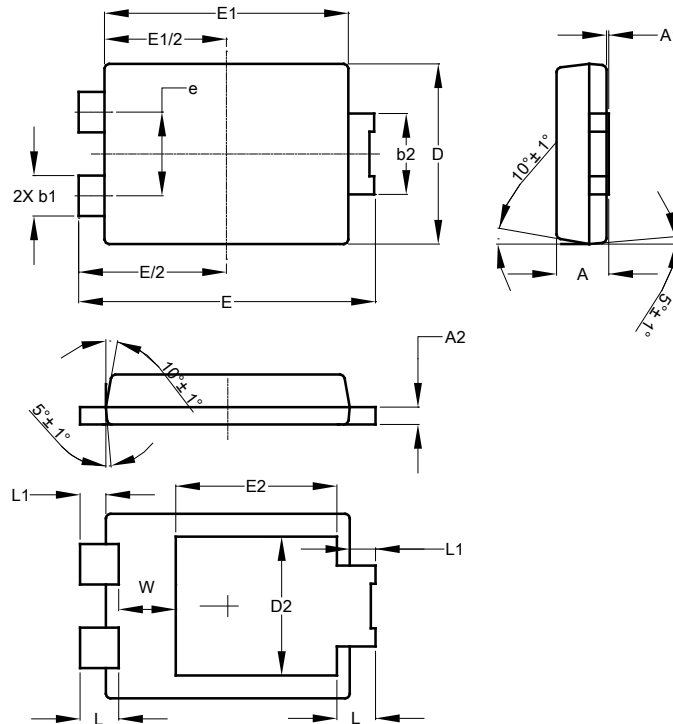


Figure 9. Reverse Recovery Time Characteristic and Test Circuit

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI5

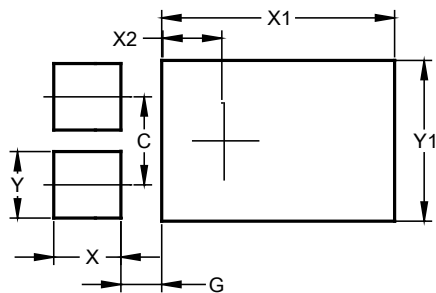


PowerDI5			
Dim	Min	Max	Typ
A	1.05	1.15	1.10
A1	0.00	0.05	--
A2	0.33	0.43	0.381
b1	0.80	0.99	0.89
b2	1.70	1.88	1.78
D	3.90	4.05	3.966
D2	--	--	3.054
E	6.40	6.60	6.51
e	--	--	1.84
E1	5.30	5.45	5.37
E2	--	--	3.549
L	0.75	0.95	0.85
L1	0.50	0.65	0.57
W	1.10	1.41	1.255
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI5



Dimensions	Value (in mm)
C	1.840
G	0.852
X	1.400
X1	4.860
X2	1.310
Y	1.390
Y1	3.360

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